

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

## TC74VHC367F, TC74VHC367FT, TC74VHC367FK TC74VHC368F, TC74VHC368FT, TC74VHC368FK

### Hex Bus Buffer

TC74VHC367F/FT/FK Non-Inverted, 3-State Outputs

TC74VHC368F/FT/FK Inverted, 3-State Outputs

The TC74VHC367 and 368 are advanced high speed CMOS HEX BUS BUFFERs fabricated with silicon gate C<sup>2</sup>MOS technology.

They achieve the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

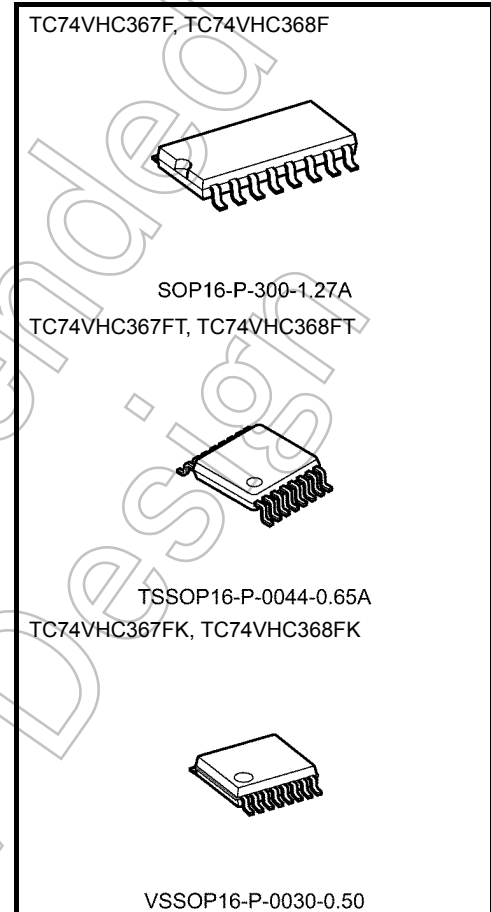
They contain six buffers; four buffers are controlled by an enable input ( $\overline{G1}$ ), and the other two buffers are controlled by another enable input ( $\overline{G2}$ ). The outputs of each buffer group are enabled when  $\overline{G1}$  and/or  $\overline{G2}$  inputs are held low; if held high, these outputs are in a high impedance state.

The TC74VHC367 is a non-inverting output type, while the TC74VHC368 is an inverting output type.

An input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

### Features

- High speed:  $t_{pd} = 3.8 \text{ ns (typ.)}$  at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 4 \mu\text{A (max)}$  at  $T_a = 25^\circ\text{C}$
- High noise immunity:  $V_{NIH} = V_{NIL} = 28\% V_{CC} \text{ (min)}$
- Power down protection is provided on all inputs.
- Balanced propagation delays:  $t_{pLH} \approx t_{pHL}$
- Wide operating voltage range:  $V_{CC (opr)} = 2 \text{ V to } 5.5 \text{ V}$
- Low noise:  $V_{OLP} = 0.8 \text{ V (max)}$
- Pin and function compatible with 74ALS367/368

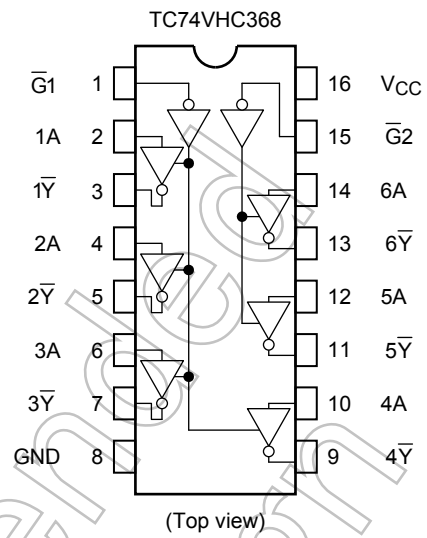
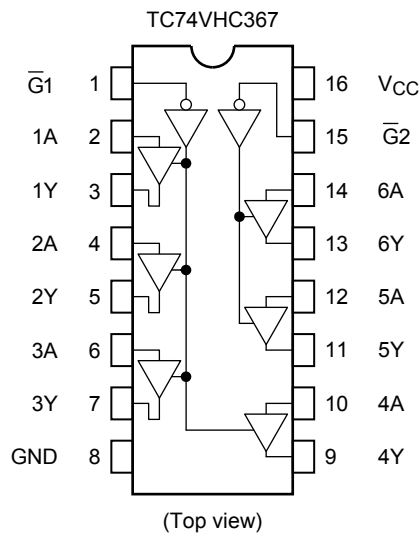


#### Weight

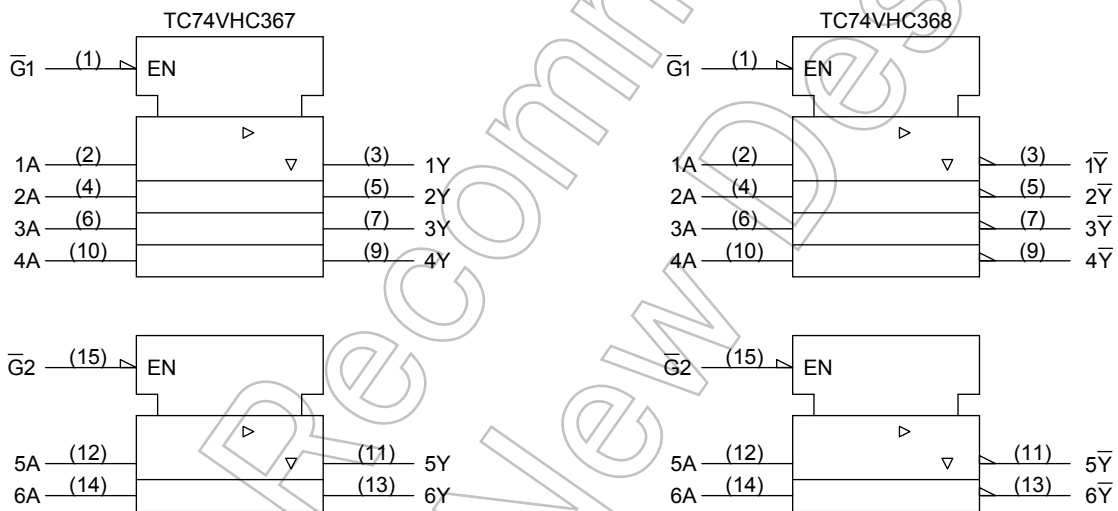
SOP16-P-300-1.27A:	0.18 g (typ.)
TSSOP16-P-0044-0.65A:	0.06 g (typ.)
VSSOP16-P-0030-0.50:	0.02 g (typ.)

Start of commercial production  
1991-05

## Pin Assignment



## IEC Logic Symbol



## Truth Table

Inputs		Outputs	
$\bar{G}$	A	Y (367)	$\bar{Y}$ (368)
L	L	L	H
L	H	H	L
H	X	Z	Z

X: Don't care

Z: High impedance

## Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage range	$V_{CC}$	-0.5 to 7.0	V
DC input voltage	$V_{IN}$	-0.5 to 7.0	V
DC output voltage	$V_{OUT}$	-0.5 to $V_{CC} + 0.5$	V
Input diode current	$I_{IK}$	-20	mA
Output diode current	$I_{OK}$	$\pm 20$	mA
DC output current	$I_{OUT}$	$\pm 25$	mA
DC $V_{CC}$ /ground current	$I_{CC}$	$\pm 50$	mA
Power dissipation	$P_D$	180	mW
Storage temperature	$T_{stg}$	-65 to 150	$^{\circ}C$

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

## Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	$V_{CC}$	2.0 to 5.5	V
Input voltage	$V_{IN}$	0 to 5.5	V
Output voltage	$V_{OUT}$	0 to $V_{CC}$	V
Operating temperature	$T_{opr}$	-40 to 85	$^{\circ}C$
Input rise and fall time	dt/dv	0 to 100 ( $V_{CC} = 3.3 \pm 0.3$ V) 0 to 20 ( $V_{CC} = 5 \pm 0.5$ V)	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

## Electrical Characteristics

### DC Characteristics

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit	
				Min	Typ.	Max	Min	Max		
High-level input voltage	$V_{IH}$	—	2.0 3.0 to 5.5	1.50 $V_{CC} \times 0.7$	— —	— —	1.50 $V_{CC} \times 0.7$	— —	V	
Low-level input voltage	$V_{IL}$	—	2.0 3.0 to 5.5	— —	— —	0.50 $V_{CC} \times 0.3$	— —	0.50 $V_{CC} \times 0.3$	V	
High-level output voltage	$V_{OH}$	$V_{IN} = V_{IH} \text{ or } V_{IL}$	$I_{OH} = -50 \mu\text{A}$	2.0 3.0 4.5	1.9 2.9 4.4	2.0 3.0 4.5	— — —	1.9 2.9 4.4	— — —	V
			$I_{OH} = -4 \text{ mA}$	3.0	2.58	—	—	2.48	—	
			$I_{OH} = -8 \text{ mA}$	4.5	3.94	—	—	3.80	—	
Low-level output voltage	$V_{OL}$	$V_{IN} = V_{IH} \text{ or } V_{IL}$	$I_{OL} = 50 \mu\text{A}$	2.0 3.0 4.5	— — —	0.0 0.0 0.0	0.1 0.1 0.1	— — —	0.1 0.1 0.1	V
			$I_{OL} = 4 \text{ mA}$	3.0	—	—	0.36	—	0.44	
			$I_{OL} = 8 \text{ mA}$	4.5	—	—	0.36	—	0.44	
3-state output off-state current	$I_{OZ}$	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or } \text{GND}$	5.5	—	—	$\pm 0.25$	—	$\pm 2.50$	$\mu\text{A}$	
Input leakage current	$I_{IN}$	$V_{IN} = 5.5 \text{ V or GND}$	0 to 5.5	—	—	$\pm 0.1$	—	$\pm 1.0$	$\mu\text{A}$	
Quiescent supply current	$I_{CC}$	$V_{IN} = V_{CC} \text{ or GND}$	5.5	—	—	4.0	—	40.0	$\mu\text{A}$	

Not Recommended for New Design

## AC Characteristics (input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit	
		V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Typ.	Max	Min	Max		
Propagation delay time (TC74VHC367)	t <sub>pLH</sub>	—	3.3 ± 0.3	15	—	5.9	8.3	1.0	10.0	ns
				50	—	8.4	11.8	1.0	13.5	
	5.0 ± 0.5		15	—	4.1	5.9	1.0	7.0		
			50	—	5.6	7.9	1.0	9.0		
Propagation delay time (TC74VHC368)	t <sub>pLH</sub>	—	3.3 ± 0.3	15	—	5.3	7.5	1.0	9.0	ns
				50	—	7.8	11.0	1.0	12.5	
	5.0 ± 0.5		15	—	3.8	5.5	1.0	6.5		
			50	—	5.3	7.5	1.0	8.5		
3-state output enable time	t <sub>pZL</sub>	R <sub>L</sub> = 1 kΩ	3.3 ± 0.3	15	—	6.8	10.5	1.0	12.5	ns
				50	—	9.3	14.0	1.0	16.0	
	5.0 ± 0.5		15	—	4.8	7.2	1.0	8.5		
			50	—	6.3	9.2	1.0	10.5		
3-state output disable time	t <sub>pLZ</sub>	R <sub>L</sub> = 1 kΩ	3.3 ± 0.3	50	—	9.9	13.6	1.0	15.5	ns
	t <sub>pHZ</sub>		5.0 ± 0.5	50	—	6.3	9.2	1.0	10.5	
Output to output skew	t <sub>osLH</sub>	(Note 1)	3.3 ± 0.3	50	—	—	1.5	—	1.5	ns
	t <sub>osHL</sub>		5.0 ± 0.5	50	—	—	1.0	—	1.0	
Input capacitance	C <sub>IN</sub>	—		—	4	10	—	10	pF	
Output capacitance	C <sub>OUT</sub>	—		—	6	—	—	—	pF	
Power dissipation capacitance	C <sub>PD</sub>	—		(Note 2)	—	19	—	—	pF	

Note 1: Parameter guaranteed by design.

$$t_{osLH} = |t_{pLHm} - t_{pLHn}|, t_{osHL} = |t_{pHLm} - t_{pHLn}|$$

Note 2: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

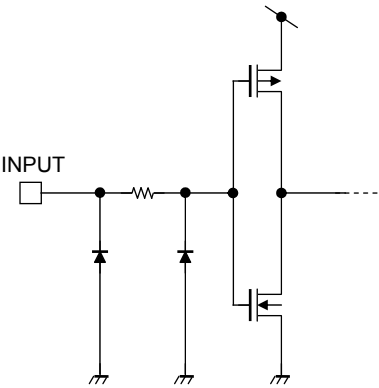
Average operating current can be obtained by the equation:

$$I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC} / 6 \text{ (per bit)}$$

## Noise Characteristics (input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	Ta = 25°C		Unit	
			V <sub>CC</sub> (V)	Typ.		Limit
Quiet output maximum dynamic V <sub>OL</sub>	V <sub>OLP</sub>	C <sub>L</sub> = 50 pF	5.0	0.4	0.8	V
Quiet output minimum dynamic V <sub>OL</sub>	V <sub>OLV</sub>	C <sub>L</sub> = 50 pF	5.0	-0.4	-0.8	V
Minimum high level dynamic input voltage	V <sub>IHD</sub>	C <sub>L</sub> = 50 pF	5.0	—	3.5	V
Maximum low level dynamic input voltage	V <sub>ILD</sub>	C <sub>L</sub> = 50 pF	5.0	—	1.5	V

**Input Equivalent Circuit**

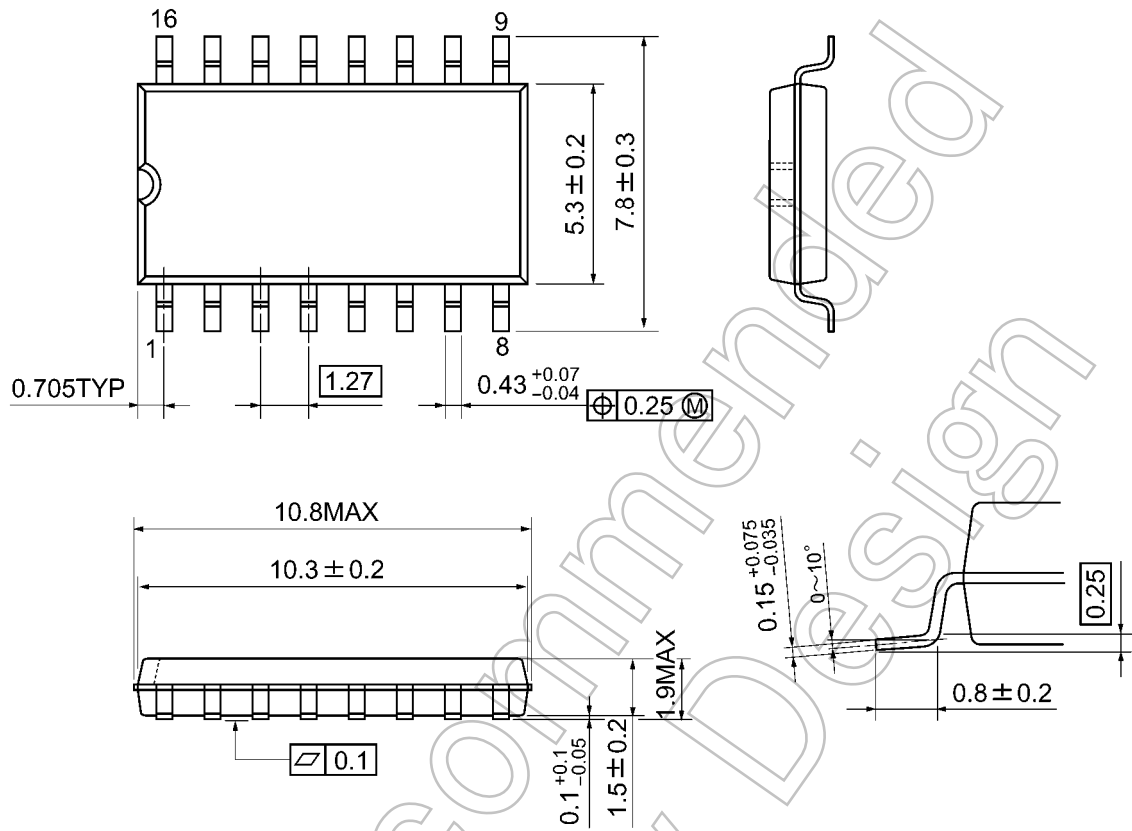


Not Recommended  
for New Design

## Package Dimensions

SOP16-P-300-1.27A

Unit: mm



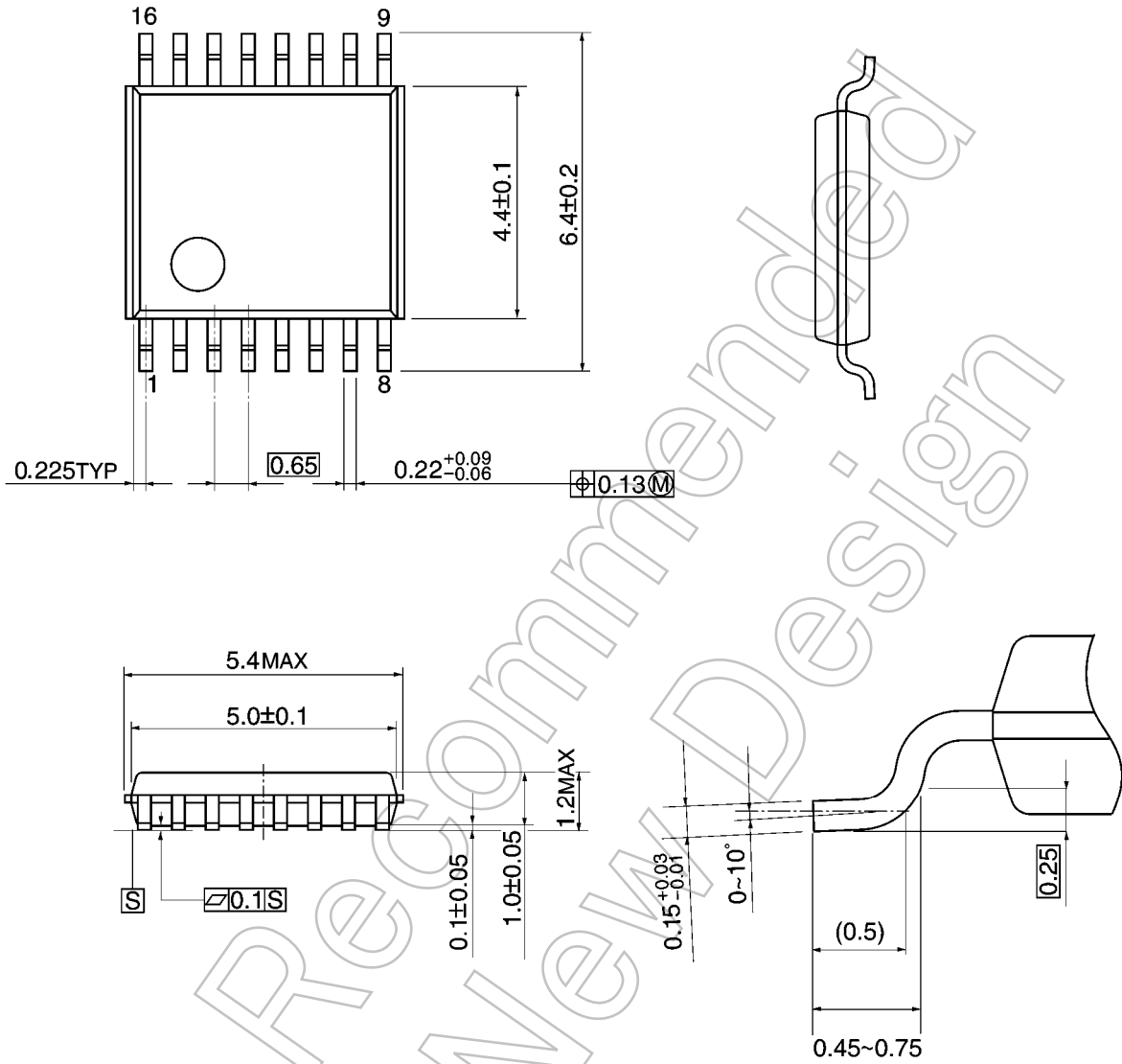
Weight: 0.18 g (typ.)

Not Recommended for New Design

**Package Dimensions**

TSSOP16-P-0044-0.65A

Unit: mm



Weight: 0.06 g (typ.)

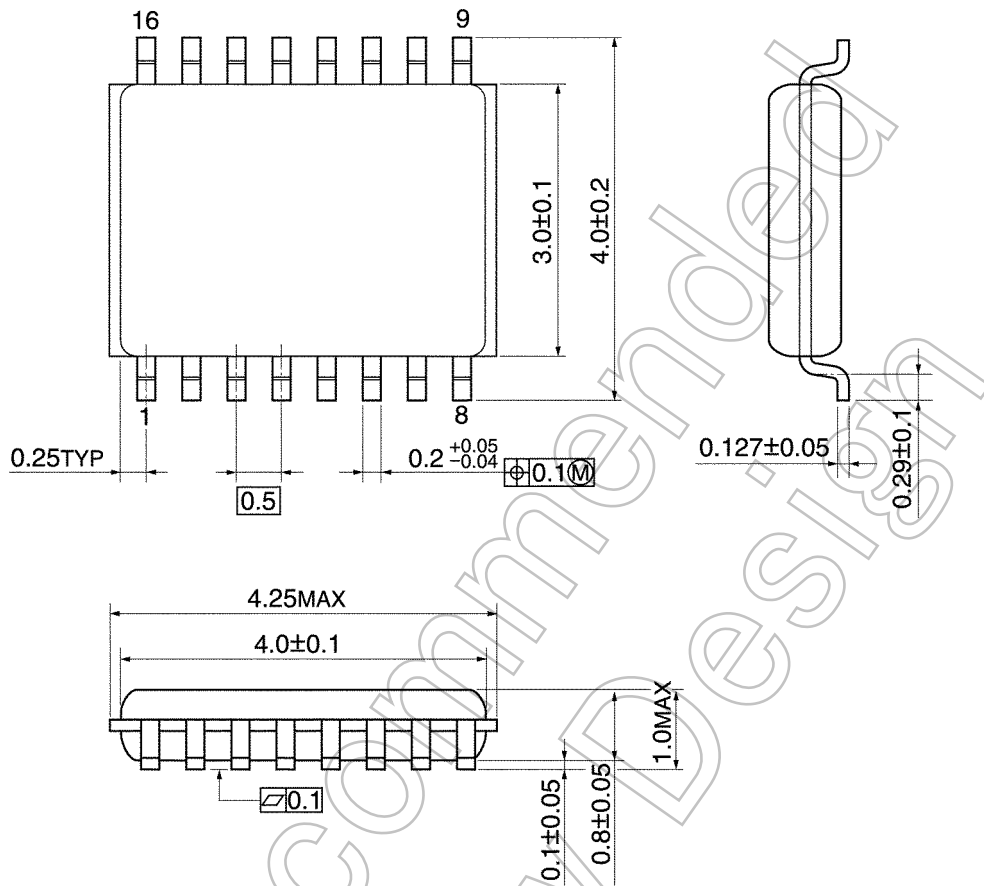
Not Recommended for New Design



**Package Dimensions**

VSSOP16-P-0030-0.50

Unit: mm



Weight: 0.02 g (typ.)

Not Recommended for New Design

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